2SK1670

Silicon N-Channel MOS FET

HITACHI

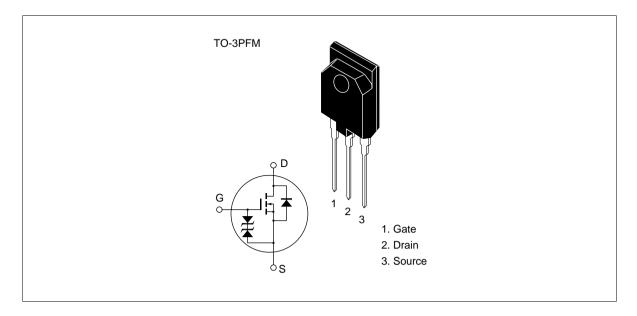
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- Built-in fast recovery diode ($t_{rr} = 90 \text{ ns}$)
- Suitable for motor control, switching regulator and DC DC converter

Outline





2SK1670

Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{\scriptscriptstyle DSS}$	250	V
Gate to source voltage	$V_{\rm GSS}$	±30	V
Drain current	I _D	30	А
Drain peak current	I _{D(pulse)} *1	120	А
Body to drain diode reverse drain current	I _{DR}	30	А
Channel dissipation	Pch*2	60	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at $T_c = 25^{\circ}C$

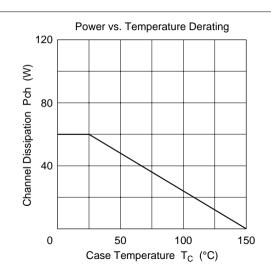
Electrical Characteristics ($Ta = 25^{\circ}C$)

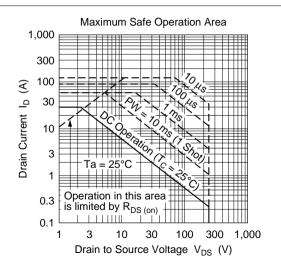
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	250	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±30	_	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	250	μΑ	$V_{DS} = 200 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	2.0	_	3.0	V	$I_{\rm D} = 1 \text{ mA}, V_{\rm DS} = 10 \text{ V}$
Static drain to source on state resistance	R _{DS(on)}	_	0.075	0.095	Ω	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{*1}$
Forward transfer admittance	y _{fs}	12	20	_	S	$I_D = 15 \text{ A}, V_{DS} = 10 \text{ V}^{*1}$
Input capacitance	Ciss	_	3100	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	1330	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	190	_	pF	
Turn-on delay time	t _{d(on)}	_	45	_	ns	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time	t,	_	170	_	ns	$R_L = 2 \Omega$
Turn-off delay time	$t_{\text{d(off)}}$	_	270	_	ns	
Fall time	t _f	_	150	_	ns	
Body to drain diode forward voltage	V_{DF}	_	1.0	_	V	$I_F = 30 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}		90		ns	$I_F = 30 \text{ A}, V_{GS} = 0,$ $di_F/dt = 100 \text{ A/}\mu\text{s}$
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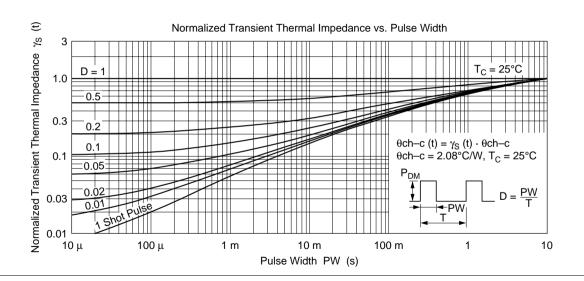
Note 1. Pulse test

See characteristic curves of 2SK1669.

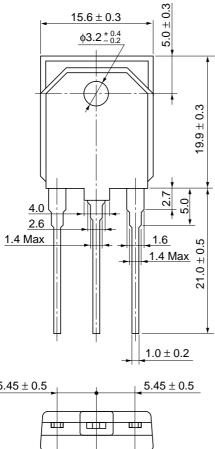
2SK1670

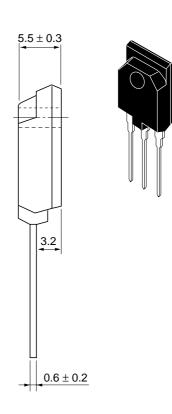






Unit: mm





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Hitachi Code	TO-3PFM
JEDEC	
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Weight (reference value)	5.6 g

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